Specification of Thermoelectric Module

TEC1-07125

Description

The 71 couples, 40 mm \times 40 mm size module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 °C, designed for superior cooling and heating up to 100 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant

Suffix

TF

TF

- Precise temperature control
- Exceptionally reliable in quality, high performance

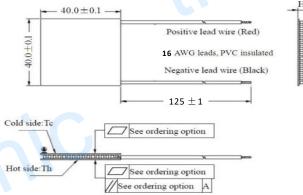
Performance Specification Sheet

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

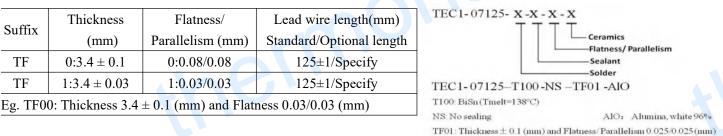
for formance specification sheet				
Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U _{max} (Voltage)	8.9	9.6	Voltage applied to the module at DT _{max}	
I _{max} (amps)	24.5	24.5	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	137.2	149.9	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (ohms)	0.28	0.30	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters



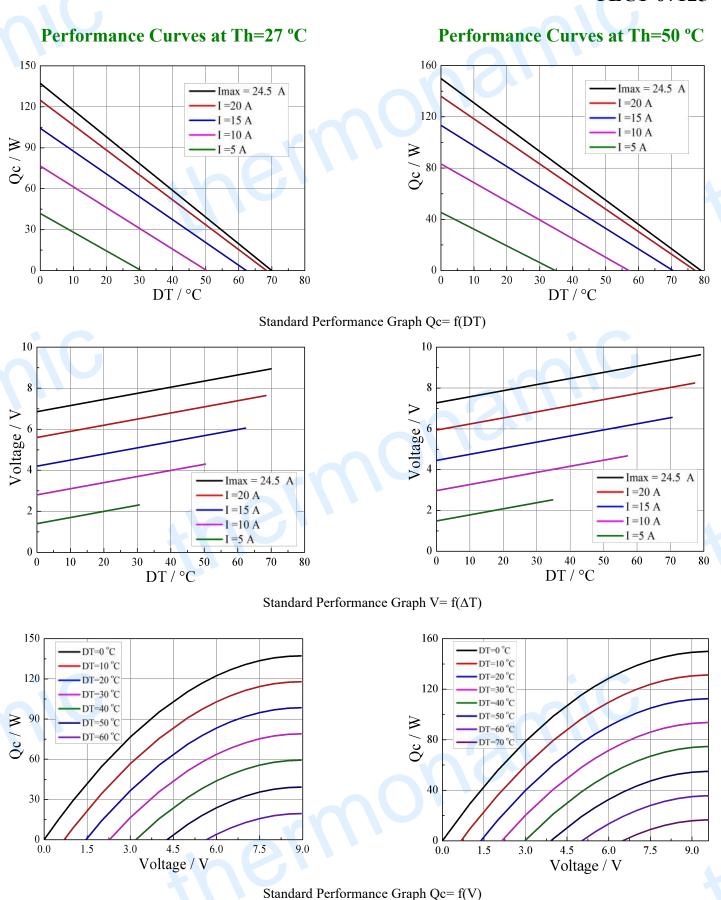
Flatness/ Parallelism Option

initial and electricity parameters				
A. Solder: B. Sealant:				
1. T100: BiSn (Tmelt=138°C)	1. NS: No sealing (Standard)			
2. T200: CuAgSn (Tmelt = 217°C)	2. SS: Silicone sealant			
3. T240: SbSn (Tmelt = 240°C)	3. EPS: Epoxy sealant			
C. Ceramics:	D. Ceramics Surface Options:			
1. Alumina (Al ₂ O ₃ , white 96%)	1. Blank ceramics (not metalized)			
2. Aluminum Nitride (AlN) Nami	2. Metalized ng for the Module			



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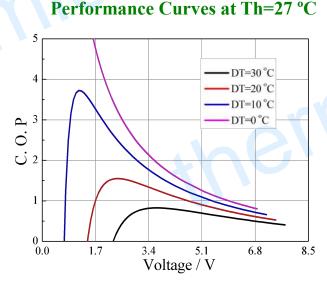
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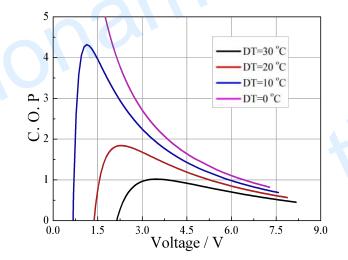
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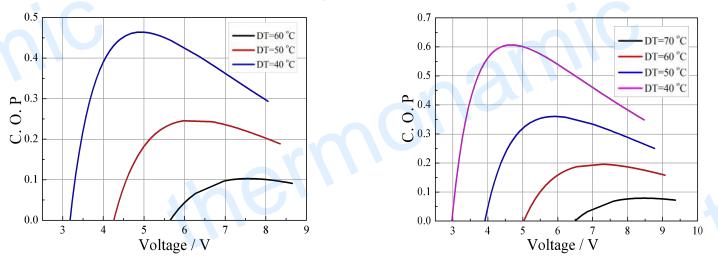
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Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of ΔT ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of ΔT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V \times I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Storage module below 100 °C
- Operation below I_{max} or V_{max}
- Work under DC